MA2SP060G

Silicon planar type

For high frequency switch

■ Features

• Low terminal capacitance: $C_t \le 0.6 \text{ pF}$ • Low forward dynamic resistance: $r_f \le 1.2 \Omega$

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	V_R	60	V
Forward current	I_F	100	mA
Junction temperature	T _j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

■ Package

• Code

SSMini2-F4

• Pin Name

1: Anode

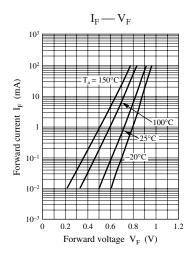
2: Cathode

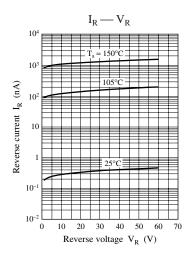
■ Marking Symbol: 6P

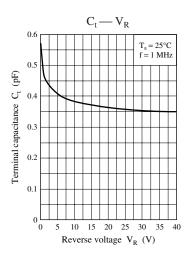
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

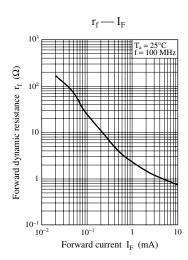
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V_{F}	$I_F = 10 \text{ mA}$		0.85	1.0	V
Reverse current	I_R	$V_R = 60 \text{ V}$		1.0	100	nA
Terminal capacitance	C _t	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$		0.45	0.6	pF
Forward dynamic resistance	r_{f}	$I_F = 10 \text{ mA}, f = 100 \text{ MHz}$		0.80	1.2	Ω

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.



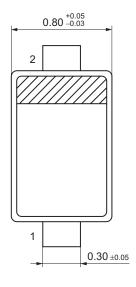


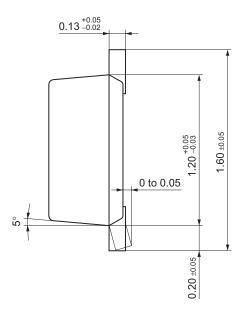


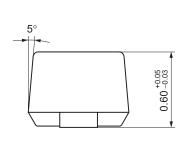


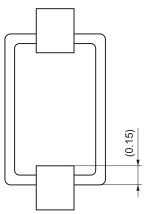
2 SKL00031AED

SSMini2-F4 Unit: mm









SKL00031AED 3

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